

REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Changes in table I. Change CAGE code identification number to 67268.	87-08-03	M. A. FRYE
B	Add case outline 2. Editorial changes throughout.	90-06-04	M. A. FRYE
C	Drawing updated to reflect current requirements. - ro	02-08-06	R. MONNIN
D	Update drawing as part of 5 year review. -rrp	09-01-20	R. HEBER
E	Update drawing to current MIL-PRF-38535 requirements. -rrp	14-12-10	C. SAFFLE

CURRENT CAGE CODE 67268

THE ORIGINAL FIRST SHEET OF THIS DRAWING HAS BEEN REPLACED.

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PMIC N/A				PREPARED BY CHARLES J. PHILLIPS					DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990 http://www.landandmaritime.dla.mil																					
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A				CHECKED BY D. A. DiCENZO																										
				APPROVED BY N. A. HAUCK																										
				DRAWING APPROVAL DATE 87-04-16																										
				REVISION LEVEL E					SIZE A	CAGE CODE 14933		5962-87540																		
										SHEET 1 OF 10																				

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:

<u>5962-87540</u>	<u>01</u>	<u>C</u>	<u>A</u>
Drawing number	Device type (see 1.2.1)	Case outline (see 1.2.2)	Lead finish (see 1.2.3)

1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	AD585	High speed, sample and hold amplifier

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
C	GDIP1-T14 or CDIP2-T14	14	Dual in line
2	CQCC1-N20	20	Square leadless chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings. ^{1/}

Supply voltages (+V _S , -V _S)	±18 V dc
Logic inputs	±V _S
Analog inputs	±V _S
R _{IN} , R _{FB} pins	±V _S
Output short circuit to ground	Indefinite
TTL logic reference short circuit to ground	Indefinite
Storage temperature range	-65°C to +150°C
Lead temperature (soldering, 10 seconds)	+300°C
Thermal resistance, junction to case (θ _{JC})	See MIL-STD-1835
Thermal resistance, junction to ambient (θ _{JA})	110°C/W

1.4 Recommended operating conditions.

Positive supply voltage (+V _S)	+5 V dc to +18 V dc
Negative supply voltage (-V _S)	-12 V dc to -18 V dc
Ambient operating temperature range (T _A)	-55°C to +125°C

^{1/} Unless otherwise specified, all voltages referenced to ground.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

5962-87540

REVISION LEVEL
E

SHEET
2

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <http://quicksearch.dla.mil/> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used. This drawing has been modified to allow the manufacturer to use the alternate die/fabrication requirements of paragraph A.3.2.2 of MIL-PRF-38535 or other alternative approved by the qualifying activity.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outline. The case outline shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Block diagram. The block diagram shall be as specified on figure 2.

3.2.2 Logic diagram and terminal connections. The logic diagram and terminal connections shall be as specified on figure 1.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

5962-87540

REVISION LEVEL
E

SHEET
3

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Offset voltage	V _{OS}	V _{OUT} = 0 V	1,2,3	01	-3	+3	mV
			4		-2	+2	
Bias current	I _B	V _{IN} = 0 V	1	01	-2	+2	nA
Bias current over temperature	I _{BΔT}	V _{IN} = 0 V	2	01	-50	+50	nA
TTL reference output	V _{LREF}	50 μA load	1	01	1.2	1.6	V
TTL reference output over temperature	V _{LREFΔT}	50 μA load	2,3	01	0.8	1.9	V
Logic input high voltage	V _{IH}	Hold = V _{LREF}	1	01	2.0		V
Logic input high voltage over temperature	V _{IHΔT}	Hold = V _{LREF}	2,3	01	2.0		V
Logic input low voltage	V _{IL}	Hold = V _{LREF}	1	01		0.8	V
Logic input low over voltage over temperature	V _{ILΔT}	Hold = V _{LREF}	2,3	01		0.7	V
Logic input current	I _{IL}	V _S = ±18 V	1,2,3	01		50	μA
Supply current	I _{SS}	R _L = infinite	1,2,3	01		10	mA
Power supply rejection	PSRR	+V _S = +5 V to +18 V, -V _S = -12 V to -18 V, V _{IN} = V _{OUT} = 0 V, T _A = +25°C	1	01	70		dB
Acquisition time	t _{acq}	10 V step to 0.01 %, T _A = +25°C	7	01		3	μs
		20 V step to 0.01 %, 3/ T _A = +25°C				5	
Droop rate 2/ 4/	V _{DRP}	V _{IN} = 0 V, T _A = +25°C	4	01		1	mV/ms

See footnotes at end of table.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-87540

SHEET
4

TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions <u>1/</u> $-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Sample to hold offset <u>2/</u>	SHOS	$V_{IN} = 0\text{ V}, T_A = +25^{\circ}\text{C}$	4	01		3	mV
Application resistor mismatch	ΔR_M		1,2,3	01		0.3	%
Common mode rejection	CMRR	$V_{CM} = \pm 10\text{ V}, T_A = +25^{\circ}\text{C}$	1	01	80		dB
Common mode rejection over temperature	CMRR ΔT	$V_{CM} = \pm 10\text{ V}$	2,3	01	77		dB
Slew current <u>5/</u>	I_{SL}	$T_A = +25^{\circ}\text{C}$	4	01	850		μA
Slew current over <u>5/</u> temperature	$I_{SL\Delta T}$		2,3	01	600		μA
Output resistor	R_{OUT}	$I_{OUT} = \pm 10\text{ mA},$ $T_A = +25^{\circ}\text{C}$	1	01		0.05	Ω
Output resistor over temperature	$R_{OUT\Delta T}$	$I_{OUT} = \pm 10\text{ mA}$	2,3	01		0.10	Ω
Output current	I_{OUT}	$R_L = 100\ \Omega, T_A = +25^{\circ}\text{C}$	1	01	12		mA

1/ Unless otherwise specified, $V_S = \pm 15\text{ V}$, C_H = internal, R_L = infinite, $A = +1$, $\overline{\text{HOLD}}$ active, sample mode.

2/ Tested in hold mode.

3/ Guaranteed, if not tested, to the limits specified in table I herein.

4/ Doubles every 10°C .

5/ $V_{OUT} = 20\text{ Vp-p}$. Slew rate = slew current / C_H .

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

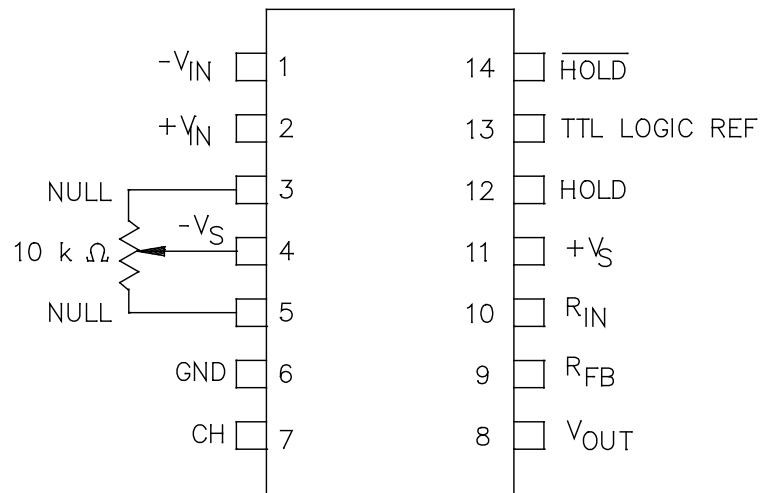
SIZE
A

5962-87540

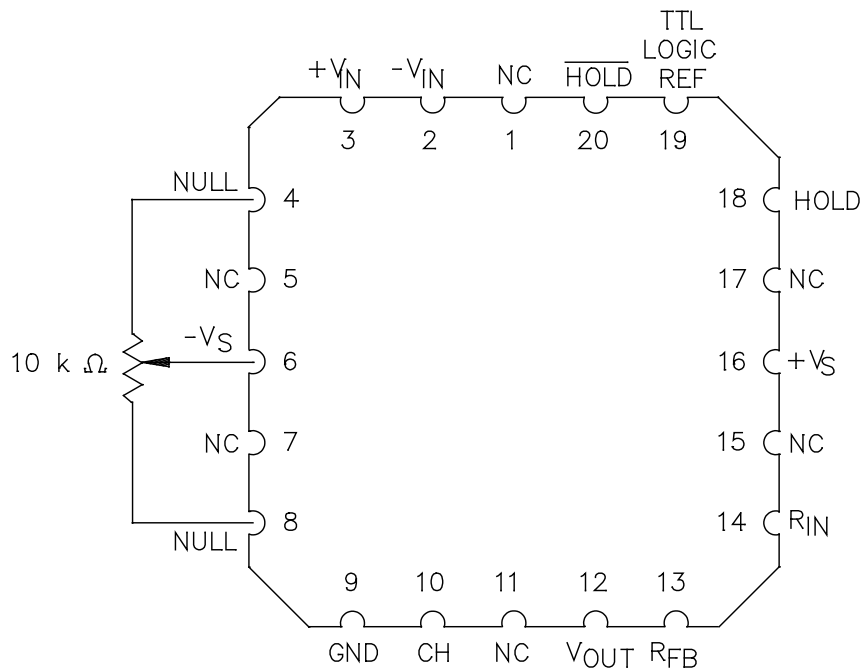
REVISION LEVEL
E

SHEET
5

CASE OUTLINE C



CASE OUTLINE 2



NOTE: For case outline 2, it is recommended that terminals 1 and 11 be connected to ground.

FIGURE 1. Terminal connections.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-87540

SHEET
6

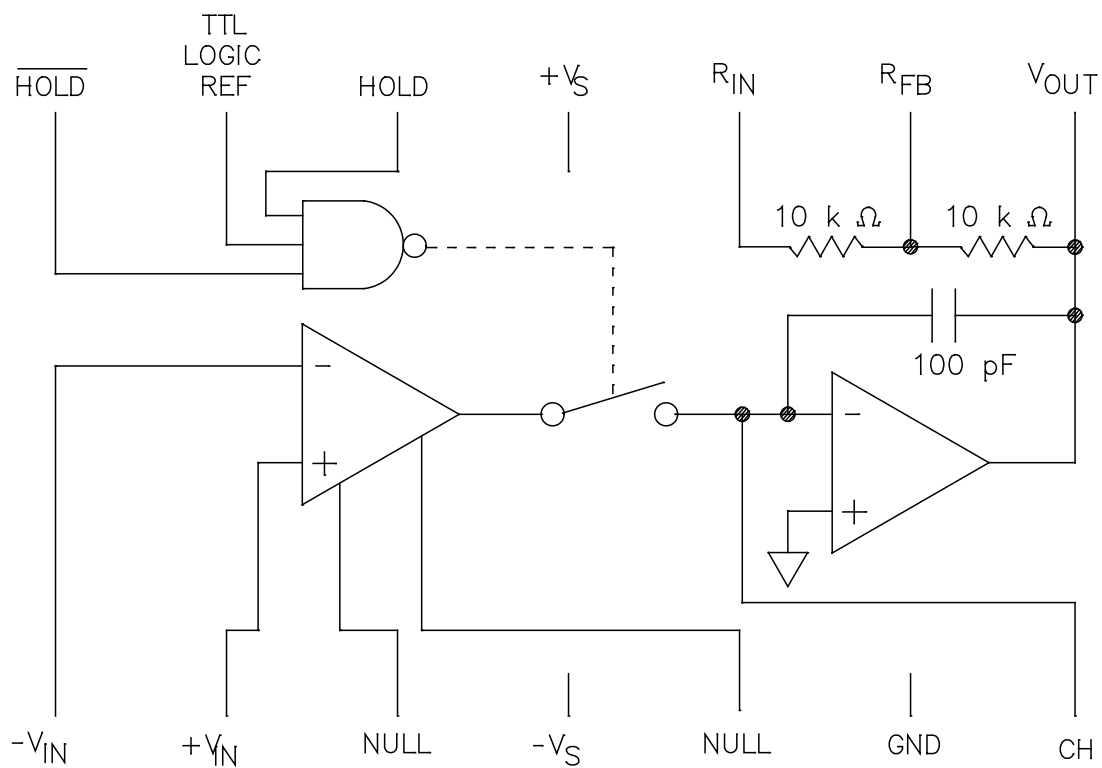


FIGURE 2. Block diagram.

**STANDARD
MICROCIRCUIT DRAWING**

DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

REVISION LEVEL
E

5962-87540

SHEET

7

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used. For product built in accordance with A.3.2.2 of MIL-PRF-38535, or as modified in the manufacturer's QM plan, the "QD" certification mark shall be used in place of the "Q" or "QML" certification mark.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DLA Land and Maritime -VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DLA Land and Maritime -VA shall be required for any change that affects this drawing.

3.9 Verification and review. DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5, 6, 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.

**STANDARD
MICROCIRCUIT DRAWING**
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990

SIZE
A

5962-87540

REVISION LEVEL
E

SHEET
8

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	1
Final electrical test parameters (method 5004)	1*, 2, 3, 4
Group A test requirements (method 5005)	1, 2, 3, 4, 7
Groups C and D end-point electrical parameters (method 5005)	1

* PDA applies to subgroup 1.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-87540
		REVISION LEVEL E	SHEET 9

6.4 Record of users. Military and industrial users shall inform DLA Land and Maritime when a system application requires configuration control and the applicable SMD to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DLA Land and Maritime -VA, telephone (614) 692-8108.

6.5 Comments. Comments on this drawing should be directed to DLA Land and Maritime -VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0540.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime -VA.

STANDARD MICROCIRCUIT DRAWING DLA LAND AND MARITIME COLUMBUS, OHIO 43218-3990	SIZE A		5962-87540
		REVISION LEVEL E	SHEET 10

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 14-12-10

Approved sources of supply for SMD 5962-87540 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime -VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <http://www.landandmaritime.dla.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-8754001CA	24355	AD585SQ/883B
5962-87540012A	24355	AD585SE/883B

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

24355

Vendor name
and address

Analog Devices
Route 1 Industrial Park
P.O. Box 9106
Norwood, MA 02062
Point of contact: 804 Woburn Street
Wilmington, MA 01887-3462

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